TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-THYRISTOR

TLP741G

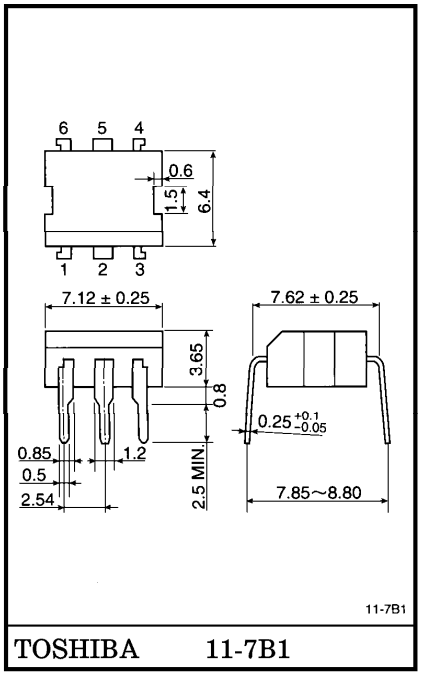
OFFICE MACHINE

HOUSEHOLD USE EQUIPMENT

SOLID STATE RELAY

SWITCHING POWER SUPPLY

Unit in mm



TOSHIBA 11-7B1

Weight : 0.35g

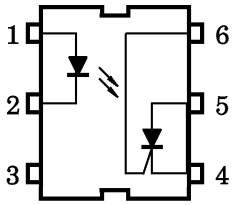
The TOSHIBA TLP741G consists of a photo-thyristor optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

- Peak Off-State Voltage : 400V (Min.)
- Trigger LED Current : 10mA (Max.)
- On-State Current : 150mA (Max.)
- UL Recognized : UL1577, File No. E67349
- BSI Approved : BS EN60065 : 1994
  Certificate No. 6617
  BS EN60950 : 1992
  Certificate No. 7366
- Isolation Voltage : 4000V_{rms} (Min.)
- Option (D4) type
  VDE Approved : DIN VDE0884 / 08, 87
  Certificate No. 65640
  Maximum Operating Insulation Voltage : 630V_{PK}
  Highest Permissible Over Voltage : 6000V_{PK}

(Note) When a VDE0884 approved type is needed, please designate the "Option (D4)"

		7.62mm pich standard type	10.16mm pich (LF2) type
Creepage Distance	:	7.0mm (Min.)	8.0mm (Min.)
Clearance	:	7.0mm (Min.)	8.0mm (Min.)
Insulation Thickness	:	0.5mm (Min.)	0.5mm (Min.)

PIN CONFIGURATIONS (TOP VIEW)



1 : ANODE
2 : CATHODE
3 : NC
4 : CATHODE
5 : ANODE
6 : GATE

MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
LED	Forward Current	I_F	60	mA
	Forward Current Derating (Ta ≧ 39°C)	ΔI_F / °C	−0.7	mA / °C
	Peak Forward Current (100 μs pulse, 100pps)	I_{FP}	1	A
	Power Dissipation	P_D	100	mW
	Power Dissipation Derating (Ta ≧ 25°C)	ΔP_D / °C	−1.0	mW / °C
	Reverse Voltage	V_R	5	V
	Junction Temperature	T_j	125	°C
DETECTOR	Peak Forward Voltage (R_{GK} = 27kΩ)	V_{DRM}	400	V
	Peak Reverse Voltage (R_{GK} = 27kΩ)	V_{RRM}	400	V
	On-State Current	$I_{T\,(RMS)}$	150	mA
	On-State Current Derating (Ta ≧ 25°C)	ΔI_T / °C	−2.0	mA / °C
	Peak On-State Current (100 μs pulse, 120pps)	I_{TP}	3	A
	Peak One Cycle Surge Current	I_{TSM}	2	A
	Peak Reverse Gate Voltage	V_{GM}	5	V
	Power Dissipation	P_D	150	mW
	Power Dissipation Derating (Ta ≧ 25°C)	ΔP_D / °C	−2.0	mW / °C
	Junction Temperature	T_j	100	°C
Storage Temperature Range		T_{stg}	−55~125	°C
Operating Temperature Range		T_{opr}	−55~100	°C
Lead Soldering Temperature (10s)		T_{sol}	260	°C
Total Package Power Dissipation		P_T	250	mW
Total Package Power Dissipation Derating (Ta ≧ 25°C)		ΔP_T / °C	−3.3	mW / °C
Isolation Voltage (AC, 1 min., R.H. ≦ 60%)		BV_S	4000	V_{rms}

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V_{AC}	—	—	120	V_{ac}
Forward Current	I_F	15	20	25	mA
Operating Temperature	T_{opr}	−25	—	85	°C
Gate to Cathode Resistance	R_{GK}	—	27	33	kΩ
Gate to Cathode Capacity	C_{GK}	—	0.01	0.1	μF

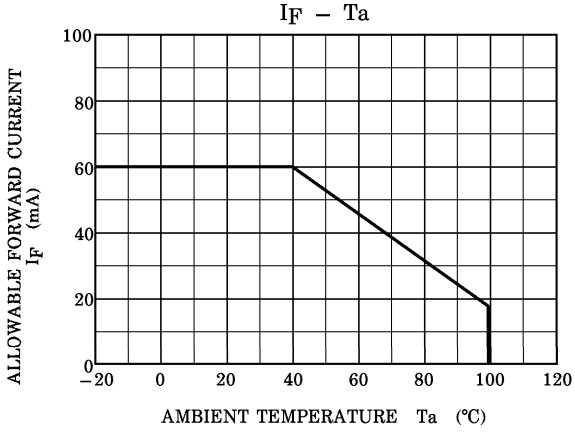
INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
LED	Forward Voltage	V_F	I_F = 10mA		1.0	1.15	1.3	V
	Reverse Current	I_R	V_R = 5V		—	—	10	μA
	Capacitance	C_T	V = 0, f = 1MHz		—	30	—	pF
DETECTOR	Off-State Current	I_{DRM}	V_{AK} = 400V, R_{GK} = 27kΩ	Ta = 25°C	—	10	5000	nA
				Ta = 100°C	—	1	100	μA
	Reverse Current	I_{RRM}	V_{KA} = 400V, R_{GK} = 27kΩ	Ta = 25°C	—	10	5000	nA
				Ta = 100°C	—	1	100	μA
	On-State Voltage	V_{TM}	I_{TM} = 100mA		—	0.9	1.3	V
	Holding Current	I_H	R_{GK} = 27kΩ		—	0.2	—	mA
	Off-State dv/dt	dv/dt	V_D = 280V, R_{GK} = 27kΩ		5	10	—	V/μs
	Capacitance	C_j	V = 0, f = 1MHz	Anode to Gate	—	20	—	pF
				Gate to Cathode	—	350	—	

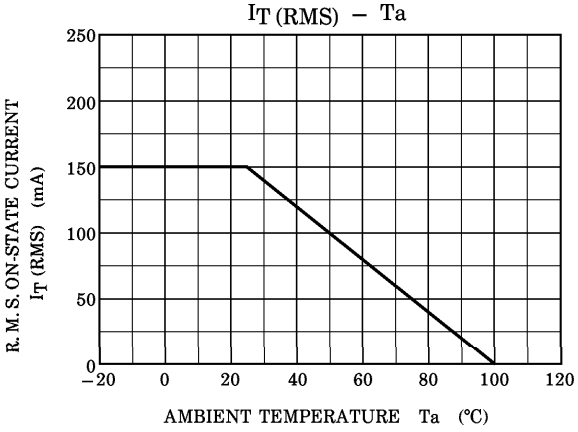
COUPLED CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I_{FT}	V_{AK} = 6V, R_{GK} = 27kΩ	—	4	10	mA
Turn-on Time	t_{ON}	I_F = 30mA, V_{AA} = 50V, R_{GK} = 27kΩ	—	10	—	μs
Coupled dv/dt	dv/dt	V_S = 500V, R_{GK} = 27kΩ	500	—	—	V/μs
Capacitance (Input to Output)	C_S	V_S = 0, f = 1MHz	—	0.8	—	pF
Isolation Resistance	R_S	V_S = 500V	1×10^{12}	10^{14}	—	Ω
Isolation Voltage	BV_S	AC, 1 minute	4000	—	—	V_{rms}
		AC, 1 second, in oil	—	10000	—	
		DC, 1 minute, in oil	—	10000	—	V_{dc}

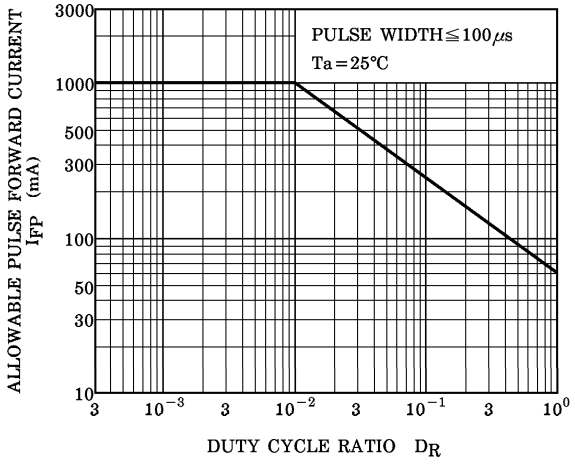
I_F – Ta



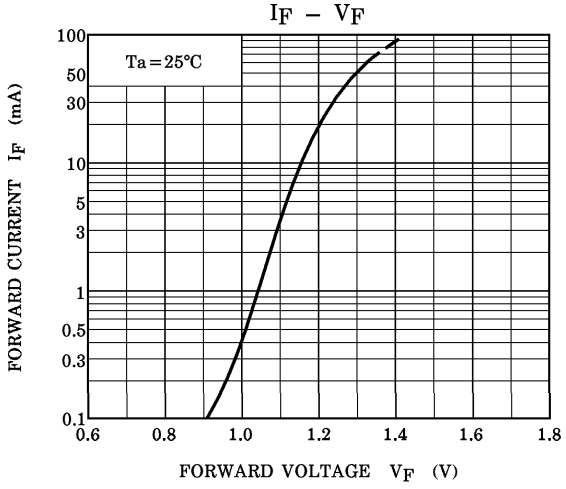
$I_{T\,(RMS)}$ – Ta



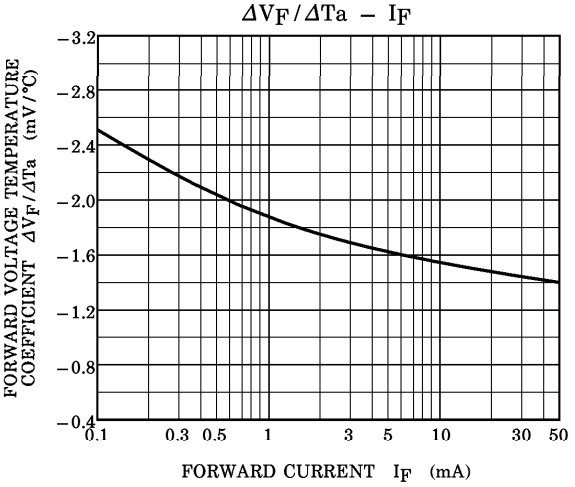
I_{FP} – D_R



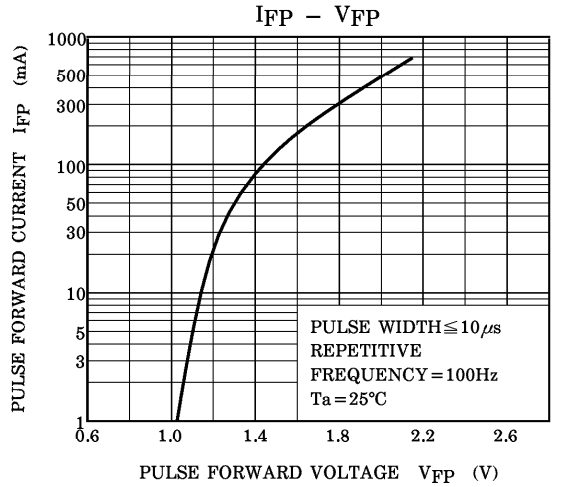
I_F – V_F



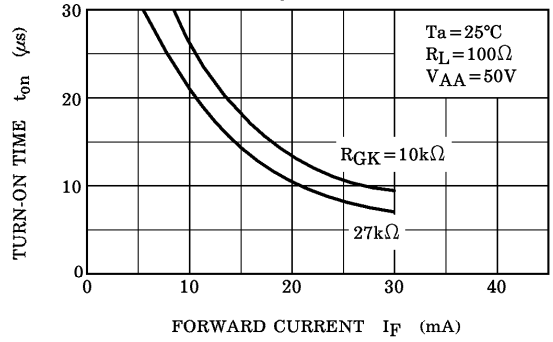
$\Delta V_F / \Delta Ta$ – I_F



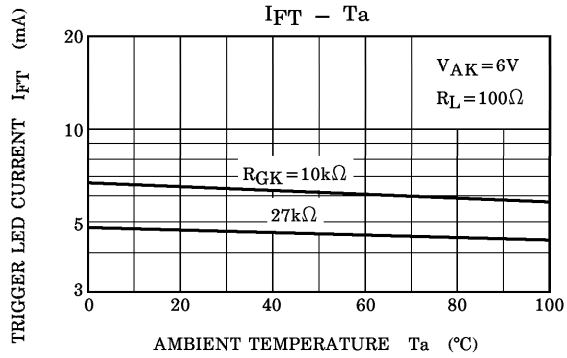
I_{FP} – V_{FP}



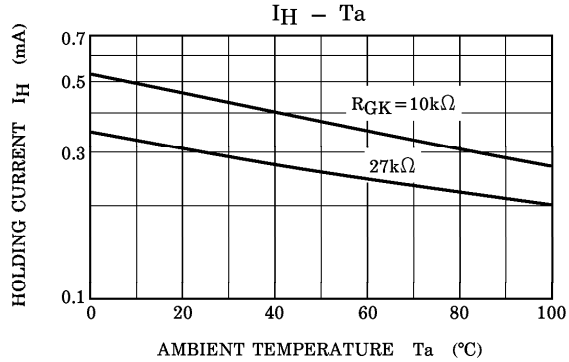
t_{on} – I_F



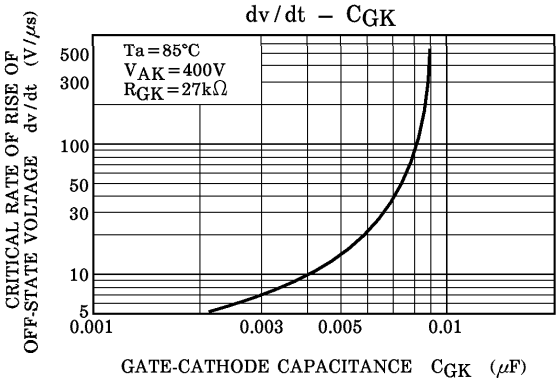
I_{FT} – Ta



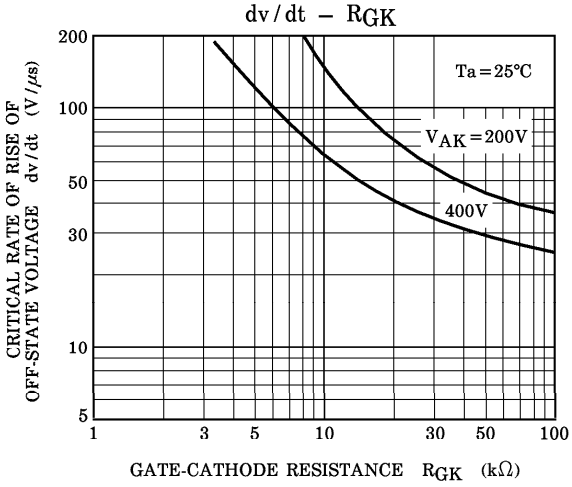
I_H – Ta



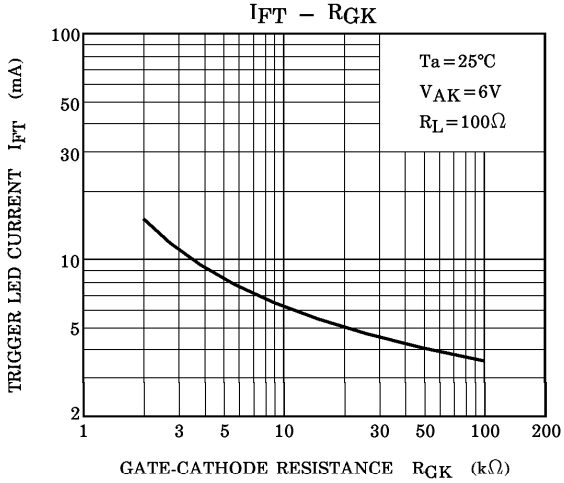
dv / dt – C_{GK}



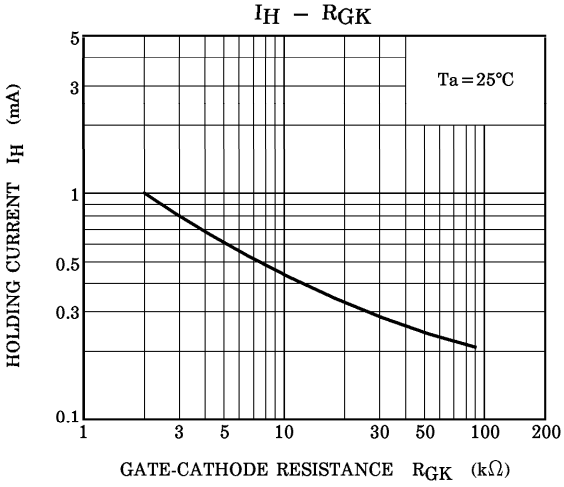
dv / dt – R_{GK}



I_{FT} – R_{GK}



I_H – R_{GK}



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